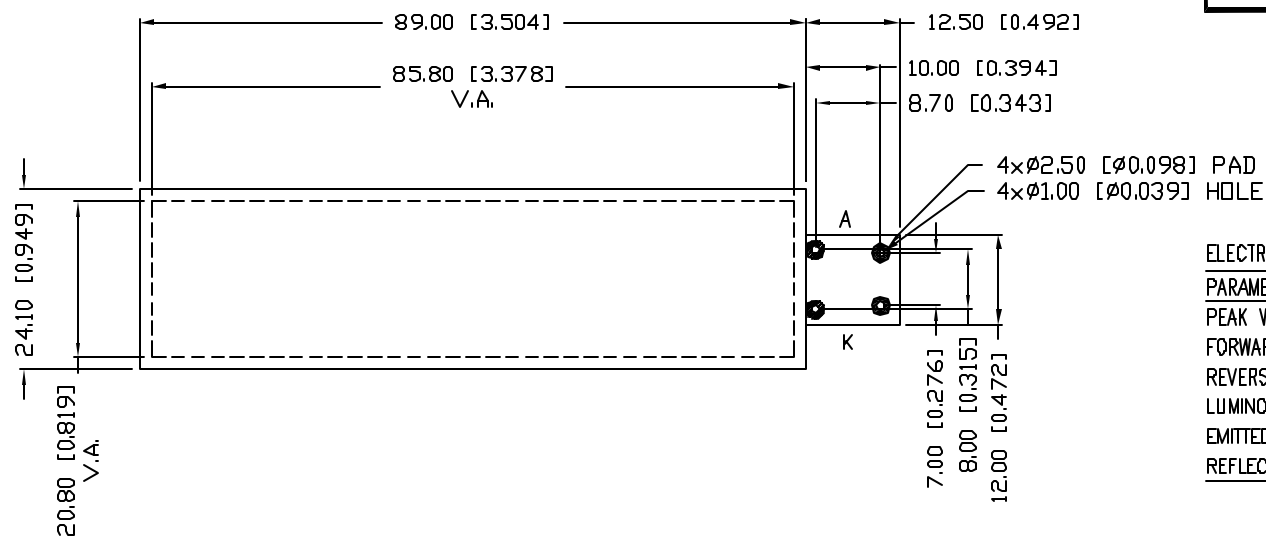
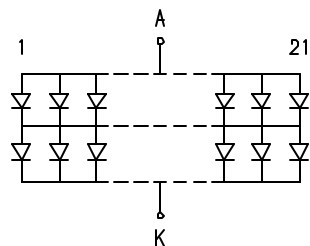
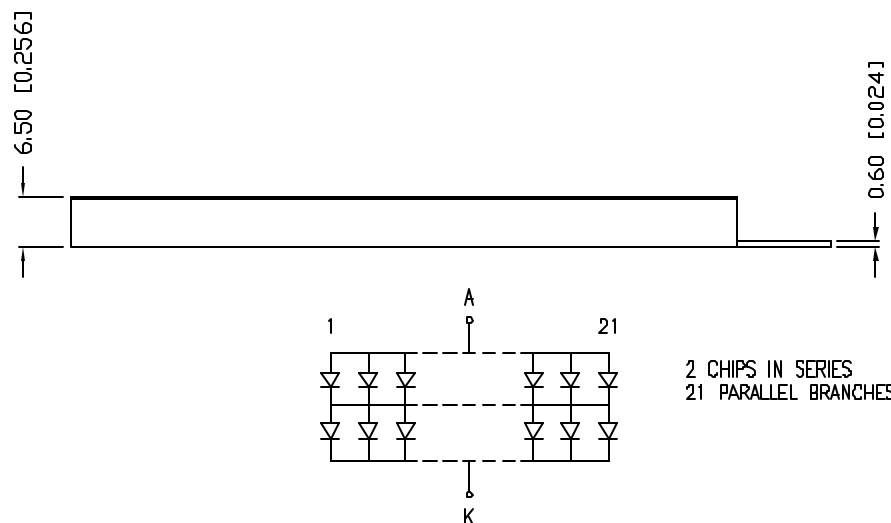




ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ PER MODULE					$I_f=210\text{mA}$
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		4.2	4.5	V_f	
REVERSE VOLTAGE	8			V_r	$V_r=2.10\text{mA}$
LUMINOUS INTENSITY		250		cd/m^2	$I_f=210\text{mA}$
EMITTED COLOR:	GREEN				
REFLECTOR FINISH:	WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C PER MODULE

PARAMETER	MAX	UNITS
STEADY CURRENT	525	mA
POWER DISSIPATION	2.4	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY	3 SEC. MAX	



2 CHIPS IN SERIES
21 PARALLEL BRANCHES

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: $X=\pm 1$ (± 0.039), $XX=\pm 0.5$ (± 0.020), $XXX=\pm 0.25$ (± 0.010), $XXXX=\pm 0.127$ (± 0.005). LEAD SIZE= ± 0.05 (± 0.002), LEAD LENGTH= ± 0.75 (± 0.030). MIN= +DECIMAL PRECISION -0.00 MAX= +0.00 -DECIMAL PRECISION

REV.

PART NUMBER

SSB-COB8621GW

CONFIDENTIAL INFORMATION

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

DRAWN BY:

CHECKED BY:

APPROVED BY:

DATE: 7.30.04

PAGE: 1 OF 1

SCALE: N/A

86mm x 21mm VIEW AREA, CHIPS ON BOARD LED

BACKLIGHT, 565nm GREEN, 42 CHIPS, 4.2V @ 210mA.

JD